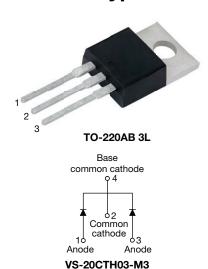


www.vishay.com

### Vishay Semiconductors

# Hyperfast Rectifier, 2 x 10 A FRED Pt®



PRIMARY CHARACTERISTICS									
I <sub>F(AV)</sub> 2 x 10 A									
$V_{R}$	300 V								
V <sub>F</sub> at I <sub>F</sub>	0.85 V								
t <sub>rr</sub> typ.	See Recovery table								
$T_J$ max.	175 °C								
Package	TO-220AB 3L								
Circuit configuration	Common cathode								

#### **FEATURES**

- Hyperfast recovery time
- Low forward voltage drop
- 175 °C operating junction temperature
- Low leakage current



HALOGEN

- Designed and qualified according to JEDEC®-JESD 47
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

#### **DESCRIPTION / APPLICATIONS**

300 V series are the state of the art hyperfast recovery rectifiers designed with optimized performance of forward voltage drop and hyperfast recovery time.

The planar structure and the platinum doped life time control, guarantee the best overall performance, ruggedness and reliability characteristics.

These devices are intended for use in the output rectification stage of SMPS, UPS, DC/DC converters as well as freewheeling diodes in low voltage inverters and chopper motor drives.

Their extremely optimized stored charge and low recovery current minimize the switching losses and reduce over dissipation in the switching element and snubbers.

ABSOLUTE MAXIMUM RATINGS										
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS						
Peak repetitive reverse voltage	$V_{RRM}$		300	V						
Average restified forward current per diode		T <sub>C</sub> = 160 °C	10							
Average rectified forward current per device	I <sub>F(AV)</sub>		20	Α						
Non-repetitive peak surge current	I <sub>FSM</sub>	T <sub>J</sub> = 25 °C	120							
Operating junction and storage temperatures	T <sub>J</sub> , T <sub>Stg</sub>		-65 to +175	°C						

<b>ELECTRICAL SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)									
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS			
Breakdown voltage, V <sub>BR</sub> , blocking voltage V <sub>R</sub>		I <sub>R</sub> = 100 μA	300	-	-	.,			
For and allows	V <sub>F</sub>	I <sub>F</sub> = 10 A - 1.05				V			
Forward voltage		I <sub>F</sub> = 10 A, T <sub>J</sub> = 125 °C	-	0.85	0.95	1			
Reverse leakage current	a augument	$V_R = V_R$ rated	-	-	20				
neverse leakage current	I <sub>R</sub>	$T_J = 125$ °C, $V_R = V_R$ rated - 6		6	200	μΑ			
Junction capacitance C <sub>T</sub> V <sub>R</sub> = 300 V		-	30	-	pF				
Series inductance	L <sub>S</sub>	Measured lead to lead 5 mm from package body	-	8	-	nH			



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<b>DYNAMIC RECOVERY CHARACTERISTICS</b> (T <sub>C</sub> = 25 °C unless otherwise specified)									
PARAMETER	SYMBOL	TEST CO	NDITIONS	MIN.	TYP.	MAX.	UNITS		
		$I_F = 1 A, dI_F/dt = 50 A$	/μs, V <sub>R</sub> = 30 V	-	-	35			
Reverse recovery time	t <sub>rr</sub>	$I_F = 1 A, dI_F/dt = 100$	-	-	30				
		T <sub>J</sub> = 25 °C		-	31	-	ns - A		
		T <sub>J</sub> = 125 °C	I <sub>F</sub> = 10 A dI <sub>F</sub> /dt = 200 A/μs	-	42	-			
Dook roomsons current	I <sub>RRM</sub>	T <sub>J</sub> = 25 °C		-	2.4	-			
Peak recovery current		T <sub>J</sub> = 125 °C	$V_{\rm R} = 200 \text{ V/µs}$	-	5.6	-			
Reverse recovery charge	Q <sub>rr</sub>	T <sub>J</sub> = 25 °C		-	36	-	nC		
		T <sub>J</sub> = 125 °C		-	120	-	IIC		

THERMAL - MECHANICAL SPECIFICATIONS									
PARAMETER SYMBOL TEST CONDITIONS MIN. TYP. MAX. UNITS									
Maximum junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>		-65	-	175	°C			
Thermal resistance, junction-to-case per diode	R <sub>thJC</sub>	Mounting surface, flat, smooth, and greased	-	-	1.5	°C/W			
Marking device		Case style TO-220AB 3L	20CTH03						

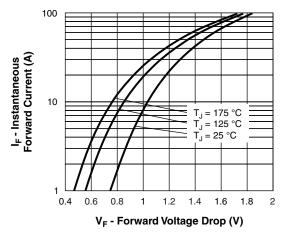


Fig. 1 - Typical Forward Voltage Drop Characteristics

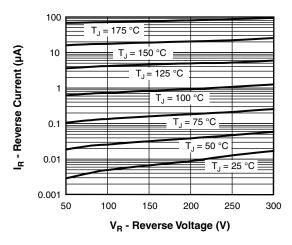


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

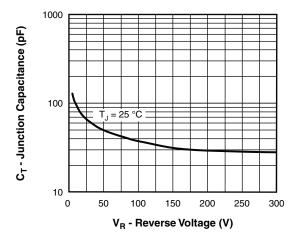


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage



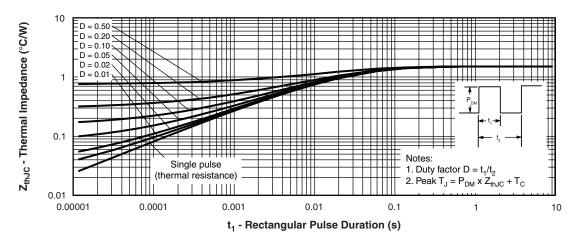


Fig. 4 - Maximum Thermal Impedance Z<sub>thJC</sub> Characteristics

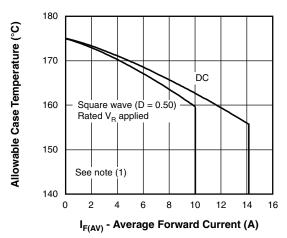


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

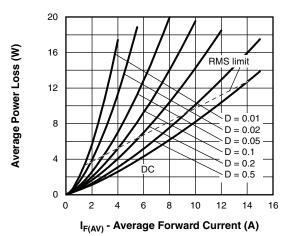


Fig. 6 - Forward Power Loss Characteristics

#### Note

 $^{(1)}$  Formula used: T<sub>C</sub> = T<sub>J</sub> - (Pd + Pd<sub>REV</sub>) x R<sub>thJC</sub>; Pd = forward power loss = I<sub>F(AV)</sub> x V<sub>FM</sub> at (I<sub>F(AV)</sub>/D) (see fig. 5); Pd<sub>REV</sub> = inverse power loss = V<sub>R1</sub> x I<sub>R</sub> (1 - D); I<sub>R</sub> at V<sub>R1</sub> = rated V<sub>R</sub>

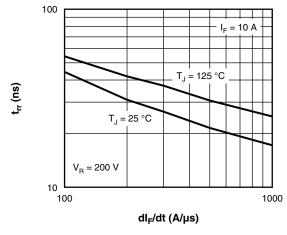


Fig. 7 - Typical Reverse Recovery Time vs. dl<sub>F</sub>/dt

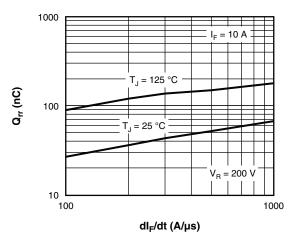
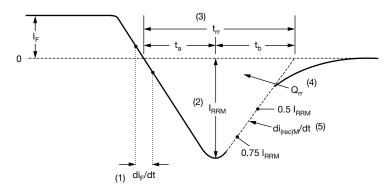


Fig. 8 - Typical Stored Charge vs. dl<sub>F</sub>/dt

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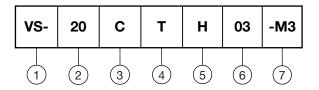


- (1) di<sub>F</sub>/dt rate of change of current through zero crossing
- (4)  $Q_{rr}$  area under curve defined by  $t_{rr}$  and  $l_{RRM}$
- (2) I<sub>RRM</sub> peak reverse recovery current
- $Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$
- (3) t<sub>rr</sub> reverse recovery time measured from zero crossing point of negative going I<sub>F</sub> to point where a line passing through 0.75 I<sub>RBM</sub> and 0.50 I<sub>RBM</sub> extrapolated to zero current.
- (5)  $di_{(rec)M}/dt$  peak rate of change of current during  $t_b$  portion of  $t_{rr}$

Fig. 9 - Reverse Recovery Waveform and Definitions

#### **ORDERING INFORMATION TABLE**

**Device code** 



- 1 Vishay Semiconductors product
- Current rating (20 = 20 A)
- **3** C = common cathode
- 4 T = TO-220, D<sup>2</sup>PAK (TO-263AB)
- **|5|** H = hyperfast recovery
- 6 Voltage rating (03 = 300 V)
- 7 Environmental digit:
  - -M3 = halogen-free, RoHS-compliant, and termination lead (Pb)-free

ORDERING INFORMATION (Example)								
PREFERRED P/N	BASE QUANTITY	PACKAGING DESCRIPTION						
VS-20CTH03-M3	50	Antistatic plastic tubes						

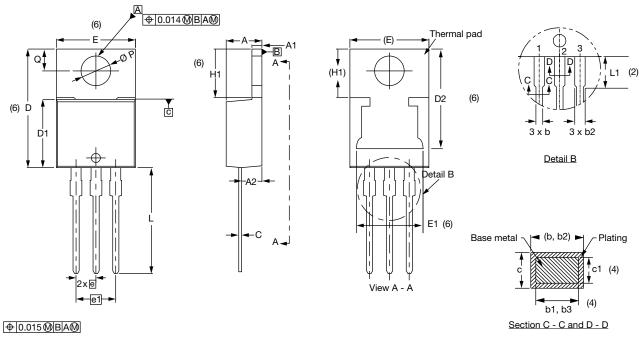
LINKS TO RELATED DOCUMENTS							
Dimensions	www.vishay.com/doc?96154						
Part marking information	www.vishay.com/doc?95028						
SPICE model	www.vishay.com/doc?96583						



## Vishay Semiconductors

### **TO-220AB 3L**

#### **DIMENSIONS** in millimeters and inches



Lead tip \	
	1

Conforms to JEDEC® outline TO-220AB

SYMBOL	MILLIN	MILLIMETERS		INCHES		NOTES	SYMBOL	MILLIMETERS		INCHES		NOTES
STWIBOL	MIN.	MAX.	MIN.	MAX.	NOTES	JIE3	STMBOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.25	4.65	0.167	0.183			D2	11.68	13.30	0.460	0.524	6, 7
A1	1.14	1.40	0.045	0.055			E	10.11	10.51	0.398	0.414	3, 6
A2	2.50	2.92	0.098	0.115			E1	6.86	8.89	0.270	0.350	6
b	0.69	1.01	0.027	0.040			е	2.41	2.67	0.095	0.105	
b1	0.38	0.97	0.015	0.038	4		e1	4.88	5.28	0.192	0.208	
b2	1.20	1.73	0.047	0.068			H1	6.09	6.48	0.240	0.255	6
b3	1.14	1.73	0.045	0.068	4		L	13.52	14.02	0.532	0.552	
С	0.36	0.61	0.014	0.024			L1	3.32	3.82	0.131	0.150	2
с1	0.36	0.56	0.014	0.022	4		ØΡ	3.54	3.91	0.139	0.154	
D	14.85	15.35	0.585	0.604	3		Q	2.60	3.00	0.102	0.118	
D1	8.38	9.02	0.330	0.355								

#### Notes

- $^{(1)}$  Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Lead dimension and finish uncontrolled in L1
- (3) Dimension D, D1, and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Dimension b1, b3, and c1 apply to base metal only
- (5) Controlling dimensions: inches
- (6) Thermal pad contour optional within dimensions E, H1, D2, and E1
- (7) Outline conforms to JEDEC® TO-220, except D2



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